

Features

- 0606 0.4mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S66TFT5R5G5B is a tri-color 0606, 6pin package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

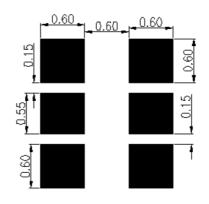
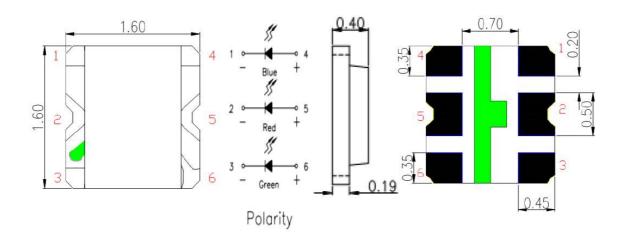


Figure 1. IN-S66TFT5R5G5B Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10 mm unless otherwise noted

Figure 2. IN-S66TFT5R5G5B Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

| Product | Emission Color | P _d (mW) | I _F (mA) | I _{FP} * (mA) | V _R (V) | T _{OP} (°C) | T _{st} (°C) |
|-----------------|----------------|---------------------|---------------------|------------------------|--------------------|----------------------|----------------------|
| | Red 60 | | | 70 | | | |
| IN-S66TFT5R5G5B | Green | 90 | 25 | 100 | 5 | -30°C~+85°C | -40ºC~+90ºC |
| | Blue | 90 | | 100 | | | |

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25$ °C (Note 1)

| Product | Emission | | V _F (V) | | λ(nm) | | | Viewing Angle | l* _v (mcd) |
|-----------------|----------|---------------------|--------------------|-----|---------------|---------------|--------------------|------------------|-----------------------|
| | Color | l _F (mA) | typ. | max | λ_{D} | λ_{P} | $	riangle \lambda$ | 2 <i>0</i> 1/2 | typ. |
| | Red | 5 | 2.0 | 2.4 | 620 | 630 | 20 | 120 | 45 |
| IN-S66TFT5R5G5B | Green | 5 | 2.8 | 3.1 | 525 | 524 | 35 | 120 | 285 |
| | Blue | 5 | 2.8 | 3.1 | 470 | 464 | 30 | 120 | 56 |

Notes

1. Performance guaranteed only under conditions listed in above tables.



Luminous Intensity (Iv) Bin:

| Color | Bin Code | Spec. Range | | | | |
|-------|----------|-----------------|--|--|--|--|
| | H1 | 28.5-35.0 mcd | | | | |
| Red | H2 | 35.0-45.0 mcd | | | | |
| Reu | J1 | 45.0-56.0 mcd | | | | |
| | J2 | 56.0-72.0 mcd | | | | |
| | M2 | 230.0-285.0 mcd | | | | |
| Green | N1 | 285.0-350.0 mcd | | | | |
| | N2 | 350.0-400.0 mcd | | | | |
| | H2 | 35.0-45.0 mcd | | | | |
| Dhuo | J1 | 45.0-56.0 mcd | | | | |
| Blue | J2 | 56.0-72.0 mcd | | | | |
| | K1 | 72.0-90.0 mcd | | | | |
| | | | | | | |

@5mA / Ta=25° C, Tolerance: ± 10%

Dominant Wavelength (λD) Bin:

| • • • • | | | | | | | |
|---------|----------|-------------|--|--|--|--|--|
| Color | Bin Code | Spec. Range | | | | | |
| | A | 615-620 | | | | | |
| Red | В | 620-625 | | | | | |
| | С | 625-630 | | | | | |
| | D | 521-524 | | | | | |
| Green | E | 524-527 | | | | | |
| | F | 527-530 | | | | | |
| | В | 461-464 | | | | | |
| Blue | С | 464-467 | | | | | |
| Diue | D | 467-470 | | | | | |
| | E | 470-473 | | | | | |
| | | | | | | | |

@5mA / Ta=25° C, Tolerance: ± 0.5nm

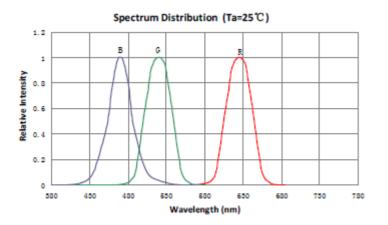
Bin Code Color Spec. Range 1.8-2.0 1 Red 2 2.0-2.2 5 2.5-2.7 6 2.7-2.9 Green 7 2.9-3.1 5 2.5-2.7 6 2.7-2.9 Blue 7 2.9-3.1

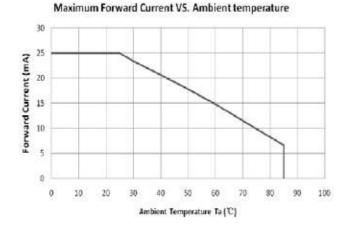
Forward Voltage (Vf) Bin:

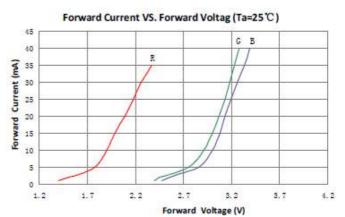
@5mA / Ta=25° C, Tolerance: ± 0.05V

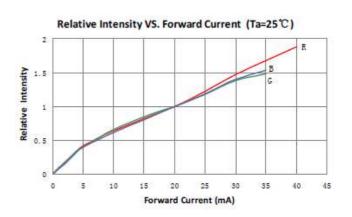


Typical Characteristic Curves

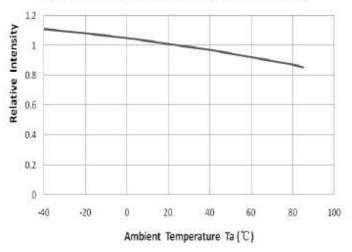






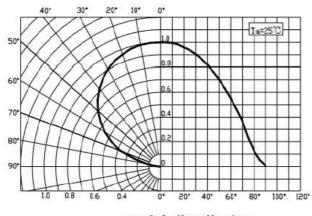








Typical Characteristic Curves – Radiation Pattern



spatial distribution

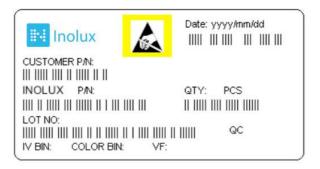
Ordering Information

| Product | Emission Color | Test Current I⊧ (mA) | Luminous Intensity Iv (mcd) (Typ.) | Forward Voltage V _F (V) (Typ.) | Orderable Part Number | |
|-----------------|----------------|-------------------------|--|--|--------------------------|--|
| | Red | 5 | 45 | 2.0 | | |
| IN-S66TFT5R5G5B | Green 5 | | 285 | 2.8 | IN-S66TFT5R5G5B | |
| | Blue | 5 | 56 | 2.8 | | |

Bin Range specified on page 3.



Label Specifications



Inolux P/N:

| I | Ν | - | S | 6 | 6 | т | F | Т | 5 | R | 5 | G | 5 | В | - | |
|---|--------------|---|-----------------|-----|------|----------------|-------|------------------|---------|-------------|---------|-------------|---------|-------------|---|-------------------------|
| | | | Material | Pac | kage | Varia | ation | Orientation | Current | Color | Current | Color | Current | Color | | Customized Stamp-off |
| | nolux SMD | | S = PCB Type | 1. | | ΓF = x 0.4m | m | T = Top Mount | 5= 5mA | R= 622nm | 5= 5mA | G= 527nm | 5= 5mA | B= 470nm | | |

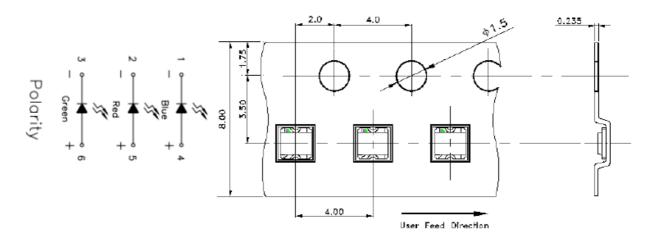
Lot No.:

| Z | 2 | 0 | 1 | 7 | 01 | 24 | 001 |
|----------|---|------------|---------|-------|------|--------|-----|
| Internal | | Year (2017 | . 2018) | Month | Date | Serial | |
| Tracker | | | ,, , | | | | |

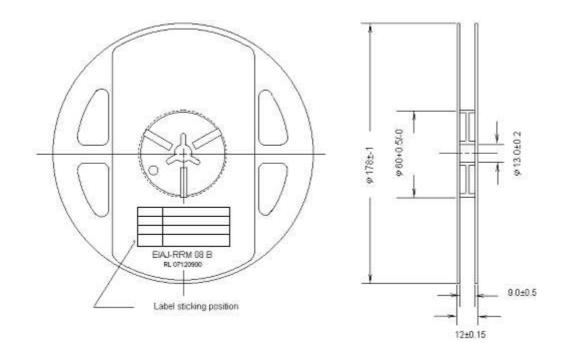


Packaging Information: 4000pcs Per Reel

Tape Dimension

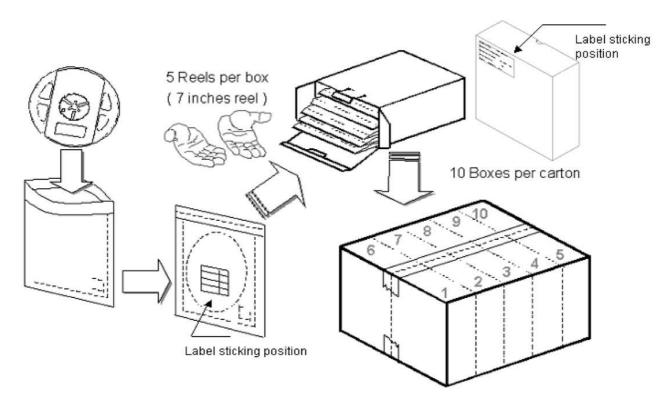


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

| Specification | Material | Quantity |
|----------------------|--|---|
| Per EIA 481-1A specs | Conductive black tape | 4000pcs per reel |
| Per EIA 481-1A specs | Conductive black | |
| IN standard | Paper | |
| 220x240mm | Aluminum laminated bag/ no-zipper | One reel per bag |
| IN standard | Paper | Non-specified |
| | Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm | Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper |

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

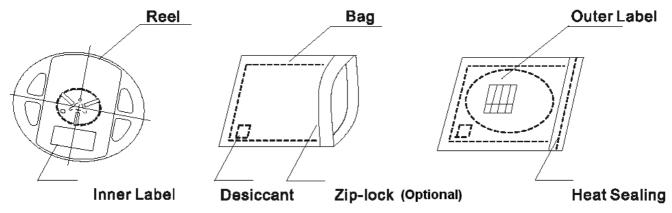


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

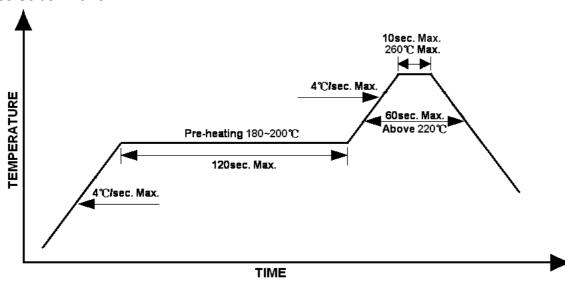
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

| ltem | Frequency/ lots/ samples/ | Standards | Conditions |
|---------------------|----------------------------|-----------------|--|
| nem | failures | Reference | |
| | For all reliability | J-STD-020 | 1.) Baking at 85°C for 24hrs |
| Precondition | monitoring tests according | | 2.) Moisture storage at 85°C/ 60% R.H. for |
| | to JEDEC Level 2 | | 168hrs |
| | 1Q/ 1/ 22/ 0 | JESD22-B102-B | Accelerated aging 155°C/ 24hrs |
| Solderability | | And CNS-5068 | Tinning speed: 2.5+0.5cm/s |
| | | | Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s |
| | | CNS-5067 | Dipping soldering terminal only |
| Resistance to | | | Soldering bath temperature |
| soldering heat | | | A: 260+/-5°C; 10+/-1s |
| | | | B: 350+/-10°C; 3+/-0.5s |
| | 1Q/ 1/ 40/ 0 | CNS-11829 | 1.) Precondition: 85°C baking for 24hrs |
| Operating life test | | | 85°C/ 60%R.H. for 168hrs |
| | | | 2.) Tamb25°C; IF=20mA; duration 1000hrs |
| High humidity, | 1Q/ 1/ 45/ 0 | JESD-A101-B | Tamb: 85°C |
| high temperature | | | Humidity: 85% R.H., IF=5mA |
| bias | 10/1/00 | IN 1 | Duration: 1000hrs |
| High temperature | 1Q/ 1/ 20 | IN specs. | Tamb: 55°C |
| bias | | | IF=20mA Duration: 1000hrs |
| | 1Q/ 1/ 40/ 0 | | Tamb25°C, If=20mA,, Ip=100mA, Duty |
| Pulse life test | 10/1/40/0 | | cycle=0.125 (tp=125 μ s,T=1sec) |
| ruise ille lest | | | Duration 500hrs) |
| | 1Q/ 1/ 76/ 0 | JESD-A104-A | A cycle: -40 degree C 15min; +85 degree C |
| | TQ/ 1/ 76/ 0 | IEC 68-2-14, Nb | 15min |
| Temperature | | 1EC 00-2-14, ND | Thermal steady within 5 min |
| cycle | | | 300 cycles |
| | | | 2 chamber/ Air-to-air type |
| High humidity | 1Q/ 1/ 40/ 0 | CNS-6117 | 60+3°C |
| storage test | | | 90+5/-10% R.H. for 500hrs |
| High temperature | 1Q/ 1/ 40/ 0 | CNS-554 | 100+10°C for 500hrs |
| storage test | | | |
| Low temperature | 1Q/ 1/ 40/ 0 | CNS-6118 | -40+5°C for 500hrs |
| storage test | | | |
| | | 1 | |

Page 11



Revision History

| Changes since last revision | Page | Version No. | Revision Date |
|-----------------------------|------|-------------|----------------------|
| Initial Release | | V1.0 | 03-20-2020 |
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